

BB02-HH

CUSTOMER PRODUCT SPECIFICATION SHEET

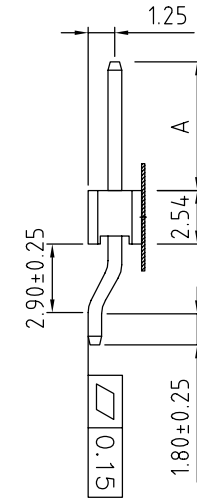
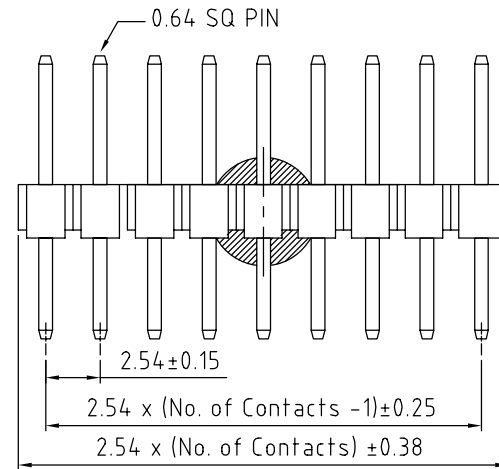
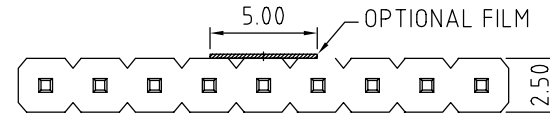


BB02-HH :- 2.54mm (0.1") PIN HEADER SMD TYPE ,SINGLE ROW, RIGHT ANGLE - 02 to 40 CONTACTS

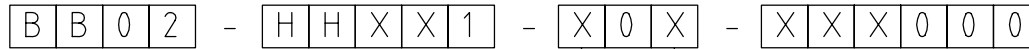
SPECIFICATIONS

CURRENT RATING 3 AMP
 INSULATOR RESISTANCE 1000 MEGOHMS MIN.
 DIELECTRIC WITHSTANDING AC 600 V
 CONTACT RESISTANCE 20 m OHMS MAX.
 OPERATING TEMPERATURE -40°C TO +105°C
 CONTACT MATERIAL BRASS
 INSULATOR MATERIAL THERMOPLASTIC, UL 94V-0
 STANDARD NYLON 6T
 PLATING GOLD, TIN OR SELECTIVE OVER 30-50U" NICKEL
 SOLDERABILITY IR REFLOW: 260°C FOR 10 SEC
 MANUAL SOLDER: 350°C FOR 3-5 SEC

MATES WITH :- BB02-JB BB02-JJ
 BB02-JC BB02-JL
 BB02-JE BB02-JS
 BB02-JF BB02-JT
 BB02-JG BB02-KR



HOW TO ORDER

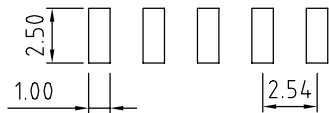


NO. OF CONTACTS
02 TO 40

CONTACT PLATING OPTIONS
 K = GOLD FLASH (STANDARD)
 A = 10U" GOLD ON CONTACT/GOLD FLASH ON TAIL
 B = 15U" GOLD ON CONTACT/GOLD FLASH ON TAIL
 C = 30U" GOLD ON CONTACT/GOLD FLASH ON TAIL
 T = BRIGHT TIN
 M = MATT TIN
 D = GOLD FLASH ON CONTACT/BRIGHT TIN ON TAIL
 E = 10U" GOLD ON CONTACT/BRIGHT TIN ON TAIL
 F = 15U" GOLD ON CONTACT/BRIGHT TIN ON TAIL
 G = 30U" GOLD ON CONTACT/BRIGHT TIN ON TAIL

PACKAGING OPTIONS
 2 - TRAY
 6 - T & R
 7 - T & R & FILM
 STANDARD = 2

PIN LENGTH A (1/10mm)
 PLEASE SPECIFY PIN
 LENGTH REQUIRED
 I.E. 2.5mm = 025
 STANDARD = 060
 TOL.: ±0.25MM



RECOMMENDED PCB LAYOUT
(TOLERANCE: ±0.05)

REV. DATE & DRN
 10 06/07/05 - NYW RELEASE
 11 15/08/06 - NYW DRAWING MODIFICATION
 12 05/06/08 - CHC PLATING MODIFICATION
 13 17/07/09 - NYW ADD FILM DRAWING REMOVE PACK OPTION B AND DRAWING MODIFICATION

Scale: 4:1	THIRD ANGLE	Unstated Tolerances: X. ± 0.30 X ± 0.25 XX ± 0.15 XXX ± 0.10	Material SEE NOTE
Drawn: CHC			
App'd: XXXX	Title PIN HEADER		NOT TO SCALE
Date: 17 JAN '09	Revision: 1.3		Unit: mm

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Type: BB02-HH
BB02-HH
 Drawing Number:
 Sheet 1 of 1
 Drawing © E and O E